

HD1520FX

HIGH VOLTAGE NPN POWER TRANSISTOR FOR HIGH DEFINITION CRT DISPLAYS

- STATE-OF-THE-ART TECHNOLOGY: DIFFUSED COLLECTOR "ENHANCED GENERATION" EHVS1
- n WIDER RANGE OF OPTIMUM DRIVE CONDITIONS
- LESS SENSITIVE TO OPERATING TEMPERATURE VARIATION
- FULLY INSULATED POWER PACKAGE U.L. COMPLIANT

APPLICATIONS

n HORIZONTAL DEFLECTION FOR LARGE AND FLAT SCREEN 100 Hz COLOR TVs

DESCRIPTION

The device is manufactured using Diffused Collector in Planar technology adopting "Enhance High Voltage Structure" (EHVS1) developed to fit High-Definition CRT displays.

The new HD product series show improved silicon efficiency bringing updated performance to the Horizontal Deflection stage.

Figure 1: Package

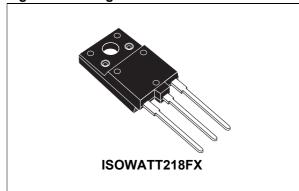


Figure 2: Internal Schematic Diagram

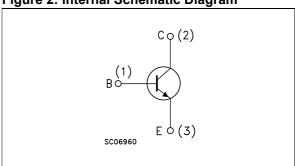


Table 1:

Part Number	Marking	Package	Packaging	
HD1520FX	HD1520FX	ISOWATT218FX	TUBE	

Table 2: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CES}	Collector-Emitter Voltage (V _{BE} = 0)	1500	V
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	700	V
V _{EBO}	Emitter-Base Voltage (I _C = 0)	10	V
I _C	Collector Current	15	Α
I _{CM}	Collector Peak Current (t _p < 5ms)	22	Α
Ι _Β	Base Current	8	Α
I_{BM}	Base Peak Current (t _p < 5ms)	12	Α
P _{tot}	Total Dissipation at T _C = 25 °C	64	W
V _{ins}	Insulation Withstand Voltage (RMS) from All Three Leads to External Heatsink	2500	V

Rev. 1

May 2005

Symbol	Parameter	Value	Unit
T _{stg}	Storage Temperature	-65 to 150	°C
TJ	Max. Operating Junction Temperature	150	°C

Table 3: Thermal Data

R _{thj-case}	Thermal Resistance Junction-Case	Max	1.95	°C/W	l
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Table 4: Electrical Characteristics (T_{case} = 25 °C unless otherwise specified)

Symbol	Parameter	Test Co	onditions	Min.	Тур.	Max.	Unit
I _{CES}	Collector Cut-off Current	V _{CE} = 1500 V				0.2	mA
	(V _{BE} = 0)	V _{CE} = 1500 V	T_C = 125 $^{\circ}C$			2	mA
I _{EBO}	Emitter Cut-off Current	V _{EB} = 5 V				10	μA
	$(I_C = 0)$						
V _{CEO(sus)} *	Collector-Emitter Sustaining Voltage	I _C = 100 mA		700			V
	$(I_B = 0)$						
V_{EBO}	Emitter-Base Voltage	I _E = 10 mA		10			V
	$(I_C = 0)$						
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 9 A	I _B = 1.8 A			3	V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 9 A	I _B = 1.8 A			1.3	V
h _{FE}	DC Current Gain	I _C = 1 A	V _{CE} = 5 V		26		
		I _C = 9 A	V _{CE} = 1 V		5		
		I _C = 9 A	$V_{CE} = 5 V$	5.5		9.5	
	INDUCTIVE LOAD	I _C = 9 A	f _h = 31250 Hz				
t_s	Storage Time	I _{B(on)} = 1.3 A	$I_{B(off)} = -4.2 A$		3.2	4	μs
t _f	Fall Time	$L_{BB(on)} = 1.9 \mu H$	$V_{BE(off)} = -2.7 V$		220	300	ns
		V _{CE(fly)} = 1040 V					

^{*} Pulsed: Pulsed duration = 300 μ s, duty cycle \leq 1.5 %.

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Figure 3: Safe Operating Area

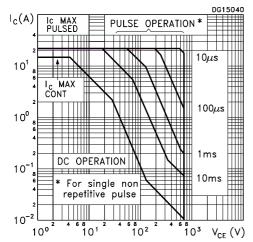


Figure 4: Output Chatacterisctics

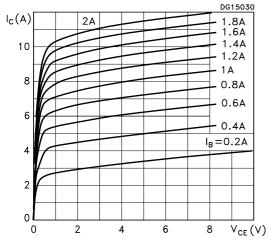


Figure 5: DC Current Gain

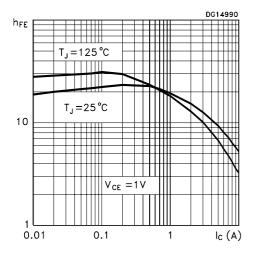


Figure 6: Derating Curve

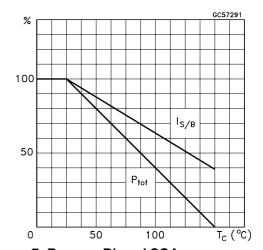


Figure 7: Reverse Biased SOA

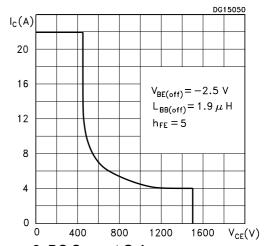


Figure 8: DC Current Gain

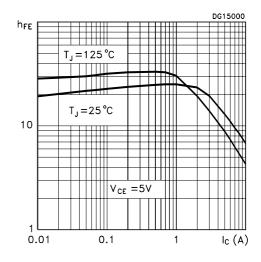


Figure 9: Collector-Emitter Saturation Voltage

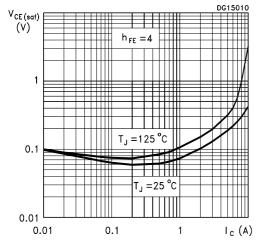


Figure 10: Power Losses

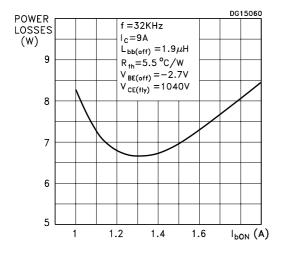


Figure 11: Base-Emitter Saturation Voltage

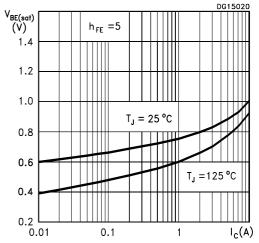
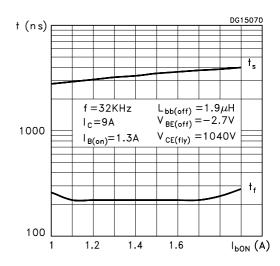


Figure 12: Inductive Load Switching Time



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Figure 13: Power Losses and Inductive Load Switching Test Circuit

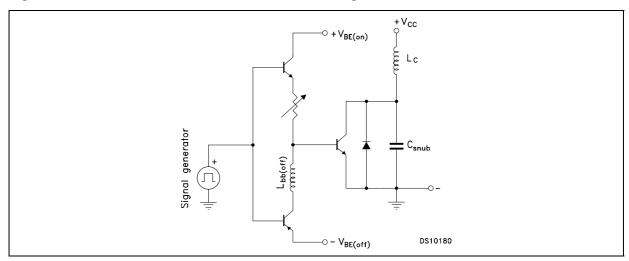
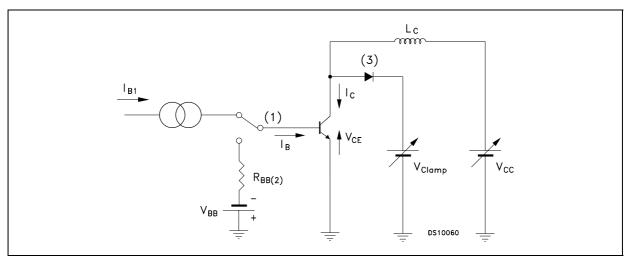


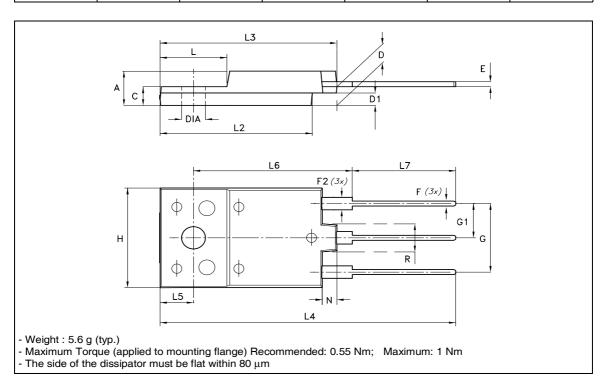
Figure 14: Reverse Biased Safe Operating Area Test Circuit



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ISOWATT218FX MECHANICAL DATA

DIM	DIM.		mm		inch		
DIN.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
Α	5.30		5.70	0.209		0.224	
С	2.80		3.20	0.110		0.126	
D	3.10		3.50	0.122		0.138	
D1	1.80		2.20	0.071		0.087	
E	0.80		1.10	0.031		0.043	
F	0.65		0.95	0.026		0.037	
F2	1.80		2.20	0.071		0.087	
G	10.30		11.50	0.406		0.453	
G1		5.45			0.215		
Н	15.30		15.70	0.602		0.618	
L	9.0		10.20	0.354		0.402	
L2	22.80		23.20	0.898		0.913	
L3	26.30		26.70	1.035		1.051	
L4	43.20		44.40	1.701		1.748	
L5	4.30		4.70	0.169		0.185	
L6	24.30		24.70	0.957		0.972	
L7	14.60		15.00	0.575		0.591	
N	1.80		2.20	0.071		0.087	
R	3.80		4.20	0.150		0.165	
DIA	3.40		3.80	0.134		0.150	



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Figure 5: Revision History

Version	Release Date	Change Designator
27-May-2005	0.1	Initial Release.

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